

DATA SHEET

SKY65364-21: 900 MHz Transmit/Receive Front-End Module

Applications

- · Automated meter reading
- · Advanced metering infrastructure
- ISM systems
- · Range extender

Features

- Transmit output power > +30 dBm
- High-efficiency PA
- · Analog power control
- Receive path NF <2.1 dB
- PA bypass mode
- LNA low-current mode with external resistor
- LNA bypass mode
- Integrated control logic
- . Internal RF match and bias circuits
- · All RF ports internally DC blocked
- Shutdown mode
- Small footprint, MCM (28-pin, 6 x 6 mm) package (MSL3, 260 °C per JEDEC J-STD-020)





Skyworks Green[™] products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green*[™], document number SQ04–0074.

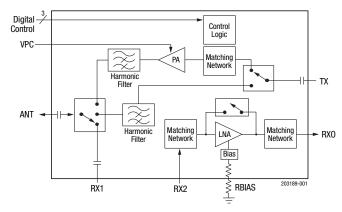


Figure 1. SKY65364-21 Functional Block Diagram

Description

The Skyworks SKY65364-21 is a high-performance, transmit/receive (T/R) front-end module (FEM). The device provides a complete T/R chain with T/R switches.

The device transmit chain features +30 dBm output power and a 40 percent power-added efficiency (PAE).

The device receive chain features a low-noise amplifier (LNA) with a 1.5 dB noise figure (NF) and 15 dB gain. The cascaded NF and gain, taking into account the 0.5 dB insertion loss transmit/receive antenna switch, are 2.1 dB and 14.5 dB, respectively, which makes the SKY65364-21 ideal for medium power microwave links such as 900 MHz Industrial, Scientific, and Medical (ISM) band applications.

The module also has a shutdown mode, PA bypass mode, and LNA bypass mode to minimize power consumption.

The device is mounted in a 28-pin, 6 x 6 mm Multi-Chip Module (MCM) surface-mount technology (SMT) package, which allows for a highly manufacturable low-cost solution.

A functional block diagram of the SKY65364-21 is shown in Figure 1. The device package and pinout for the 28-pin MCM are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

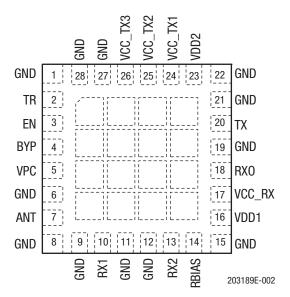


Figure 2. Figure 1. SKY65364-21 Pinout (Top View)

Table 1. SKY65364-21 Signal Descriptions

Pin	Name	Description	Pin	Name	Description
1	GND	Ground	15	GND	Ground
2	TR	Digital control input: transmit/receive mode	16	VDD1	3.3 V power supply
3	EN	Digital control input: shutdown mode	17	VCC_RX	3.3 V power supply
4	ВҮР	Digital control input: bypass mode	18	RX0	Receive output
5	VPC	Transmit output power adjustment	19	GND	Ground
6	GND	Ground	20	TX	Transmit path input port. Internally matched to 50 Ω .
7	ANT	Antenna switch common port. Internally matched to 50 Ω .	21	GND	Ground
8	GND	Ground	22	GND	Ground
9	GND	Ground	23	VDD2	3.6 V power supply
10	RX1	Receive arm of antenna switch. Internally matched to 50 Ω .	24	VCC_TX1	3.6 V power supply
11	GND	Ground	25	VCC_TX2	3.6 V power supply
12	GND	Ground	26	VCC_TX3	3.6 V power supply
13	RX2	LNA and bypass switch output port. Internally matched to 50 Ω .	27	GND	Ground
14	RBIAS	LNA bias setting resistor	28	GND	Ground

Technical Description

The SKY65364-21 consists of a complete T/R chain with T/R switches contained in the module. A single-pole, triple-throw (SP3T) switch selects between the receive, transmit, and transmit bypass paths. The module has a shut-down mode to minimize power consumption.

Three digital input pins (EN, TR, and BYP) are used to select between transmit, transmit bypass, receive, receive bypass, or shutdown mode.

Transmit Path

The transmit path contains a Power Amplifier (PA) optimized for saturated performance. The PA output is internally matched for optimum output power and efficiency into a 50 Ω load impedance. The PA output is passed through a harmonic filter before being fed through the SP3T switch. The PA input provides a good return loss into a 50 Ω source impedance.

Transmit output power is controlled by the VPC pin, which is normally set to 2.25 V DC voltage. The nominal DC input impedance into the VPC pin is 50 k Ω .

Receive Path

The receive path contains an LNA with bypass switch. The LNA impedance matching networks are internal to the module and have been optimized for a low NF while maintaining good return losses into a 50 Ω source and load impedance. The receive arm of the SP3T switch and the LNA input are connected to module pins to allow an external filter to be inserted into the receive path.

Operation Mode Control

The five SKY65364-21 operating modes are controlled by the three digital pins TR, EN, and BYP (pins 2, 3, and 4, respectively). The control logic truth is provided in Table 2.

Electrical and Mechanical Specifications

The absolute maximum ratings of the SKY65364-21 are provided in Table 3. Recommended operating conditions are specified in Table 4. Electrical specifications are provided in Tables 5, 6, and 7.

Table 2. SKY65364-21 Operating Modes Truth Table¹

		Control Voltage		Internal States					
Operating Mode	TR (Pin 2)	EN (Pin 3)	BYP (Pin 4)	PA	LNA	LNA Bypass Switch	T/R Switch	PA Bypass Switch	
Transmit	1	1	0	On	Off	Open	PA	PA	
Transmit bypass	1	1	1	Off	Off	Open	PA bypass	PA bypass	
Receive	0	1	0	Off	On	Open	RX1	Open	
Receive Bypass	0	1	1	Off	Off	Through	RX1	Open	
Shutdown ²	Х	0	Х	Off	Off	Open	Open	Open	

¹ See Table 4 for logic 0 and 1 characteristics. "X" = don't care state, defined as a valid state of logic 1 or 0.

In the high state, EN, TR, and BYP have an input current of 33 μA due to an internal 100 kΩ pulldown resistance. For the lowest leakage current, the high state is not recommended for TR and BYP when the device is in shutdown mode (EN = 0).

Table 3. SKY65364-21 Absolute Maximum Ratings¹

Parameter	Symbol	Minimum	Maximum	Units
LNA supply voltage	VCC_RX	-0.3	+5.0	V
LNA supply current	Icc_rx		20	mA
PA supply voltage	VCC_TX1/2/3	-0.3	+6.0	V
PA supply current	Icc_tx		1.6	A
Digital supply voltage	VDD1	-0.5	+5.5	V
Digital supply voltage	V _{DD} 2	-0.5	+5.5	V
Digital control voltage (EN, TR, BYP)	VCTL	-0.5	VDD1 + 0.3	V
Transmit output power control voltage	VPC	-0.3	+5.0	V
Receive RF input power (RX2)	PIN_RX2		+5	dBm
Receive bypass RF input power (RX2)	PIN_RX2_BYP		+18	dBm
Receive RF input power (ANT)	PIN_ANT		+33	dBm
Transmit RF input power	PIN_TX		+15	dBm
Transmit RF input power, bypass mode	PIN_TX_BYP		+20	dBm
Operating case temperature (Note 2)	Tc	-40	+85	°C
Storage temperature	Тѕтс	-55	+150	°C
Junction temperature	TJ		+150	°C
T/R port load VSWR in transmit mode	VSWR		10:1	-

¹ Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value.

ESD HANDLING: Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device.

This device must be protected at all times from ESD when handling or transporting. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection.

Industry-standard ESD handling precautions should be used at all times.

Table 4. SKY65364-21 Recommended Operating Conditions

Parameter	Symbol	Min	Тур	Max	Units
Transmit frequency range	f	890		960	MHz
Receive frequency range	f	900		960	MHz
LNA supply voltage	VCC_RX	3.00	3.30	3.45	V
Digital supply voltage	VDD1	3.00	VCC_RX	VCC_RX	V
Digital Supply Voltage	VDD2	3.40	VCC_TX1/2/3	3.80	V
PA supply voltage	VCC_TX1/2/3	3.40	3.60	3.80	V
Digital input voltage, logic 1 (EN, TR, BYP)	ViH	1.6		VDD1	V
Digital input voltage, logic 0 (EN, TR, BYP)	VIL	0		0.7	V
Transmit output power control voltage	VPC	0	2.25	2.50	V
Receive RF input power (RX2)	PIN_RX2			-15	dBm
Transmit RF input power (TX)	PIN_TX		+12	+13	dBm
Transmit duty cycle				50	%

 $^{^2}$ $\,$ Nominal thermal resistance, junction to case, is 18 °C/W.

Table 5. SKY65364-21 DC Electrical Specifications¹ (VCC_RX = VDD1 = 3.3 V, VCC_TX1/2/3 = VDD2 = 3.6 V, Tc = 25 °C, RBIAS = 0 Ω , No RF Input Power, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
Quiescent current, receive mode ²	IQ_RX			12		mA
Quiescent current, receive bypass mode ²	IQ_BYP			80		μΑ
VDD1 quiescent current, transmit mode	IQ_VDD1			22	30	mA
VCC_TX1/2/3 quiescent current, transmit mode	IQ_тх	Tc = 25 °C, VCC_TX1/2/3 = 3.6 V, VCC_RX = 3.3 V		18		mA
VCC_TX1/2/3 operating current, transmit mode	lop_tx	Pin = +12 dBm		680	750	mA
VDD1 quiescent current, transmit bypass mode ³	loo1			50		μΑ
VCC_TX1/2/3 quiescent current, transmit bypass mode ³	IQ_тхв			4		μΑ
VCC_RX quiescent current, shutdown mode ³	IQ_SD_RX			0.5		μΑ
VCC_TX1/2/3 quiescent current, shutdown mode ³	IQ_SD_TX			0.005		μΑ
Digital input current, logic 1 ³	Іін			33		μΑ
Digital input current, logic 0 ³	lı∟		_	0		μΑ

Performance is guaranteed only under the conditions listed in this table. Modes are established as indicated in Table 2.

 $^{^{\}rm 2}$ $\,$ Total current drawn from VCC_RX and VDD1 supplies.

 $^{^{3}\,}$ Not production tested.

Table 6. SKY65364-21 Electrical Specifications: Receive and Receive Bypass Mode¹ (1 of 2) (VCC_RX = VDD1 = 3.3 V, VCC_TX1/2/3 = VDD2 = 3.6 V, Tc = 25 °C, f = 900 to 960 MHz, 50 Ω Source and Load Impedance, CW Input, RBIAS = 0 Ω , Unless Otherwise Noted)

Parameter Symbol		Test Condition	Min	Тур	Max	Units
Receive Mode: RX2 to Receive Output I	Path					
Small signal gain	G			15		dB
Noise figure	NF	Tc = 25 °C, VCC_RX = 3.3 V		1.5	2.1	dB
Noise figure variation over temperature	NFTEMP			±0.15		dB
1 dB input compression point ²	IP1dB	1 dB gain compression		-10		dBm
Third order input intercept point ²	IIP3	P _{IN} = -30 dBm/tone, 200 kHz spacing	-3	0		dBm
Input return loss	IS11I		12	15		dB
Output return loss	IS22I		8	12		dB
Reverse isolation	IS12I			20		dB
Transition time ²	t			0.5		μS
Receive Bypass Mode: RX2 to Receive	Output Path					
Insertion loss	IL			3	5	dB
1 dB input compression point ²	IP1dB	1 dB gain compression	+15			dBm
Third order input intercept point ²	IIP3	P _{IN} = 0 dBm/tone, 200 kHz spacing		+27		dBm
Input return loss	IS11I		10	18		dB
Output return loss	IS22I		10	18		dB
Transition time ²	t			0.5		μS
Receive and Receive Bypass Mode: AN	T to RX1 Path					
Insertion loss	IL			0.5	1.0	dB
1 dB input compression point ²	IP1dBant	1 dB gain compression	+24	+30		dBm
Third order input intercept point ² IIP3ant		P _{IN} = +10 dBm/tone, 200 kHz spacing		+47		dBm
Input return loss	S11		14	19		dB
Output return loss	IS22I		14	19		dB
Transition time ²	t			3.0		μS

Performance is guaranteed only under the conditions listed in this table. Modes are established as indicated in Table 2.

² Not production tested.

Table 7. SKY65364-21 Electrical Specifications: Transmit Mode¹ (VCC_RX = VDD1 = 3.3 V, VCC_TX1/2/3 = VDD2 = 3.6 V, PIN = +12 dBm, VPC = 2.25 V, Tc = 25 °C, f = 890 to 960 MHz, 50 Ω Source and Load Impedance, CW Input, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
TX to ANT Path						
Output power ²	Роит	Tc = 25 °C, VCC_TX1/2/3 = 3.6 V	+29.5	+30		dBm
Output power variation over supply voltage		Tc = 25 °C		±0.4		dB
Output power variation over temperature		VCC_TX1/2/3 = 3.6 V		±0.3		dB
Output power control	Pctl	VPC = 0 V to 2.25 V ³	40	47		dB
Small signal transmit PA gain ⁴	Gтx	PRF input @ -30 dBm		16		dB
Power-added efficiency	PAE			40		%
2 nd harmonic	2fo				-50	dBc
3 rd to 10 th harmonic ⁵	3fo to 10fo				-50	dBc
Input return loss	IS11I			10		dB
Output return loss	IS22I			8		dB
Non-harmonic spurious ⁴	Pspur	VSWR 10:1, all phases			-50	dBm
Power on time ⁴	t			4.4		μS
TX to ANT Path, Transmit Bypass Mode						
Insertion loss	IL			1.5	2.5	dB
1 dB input compression point ⁴	IP1dB		+24	+30		dBm
Third order input intercept point ⁴	IIP3	Pin = +10 dBm/tone, 200 kHz spacing		+47		dBm
2 nd harmonic	2fo	Pin = +12 dBm		-90	-40	dBc
3 rd harmonic	3fo	P _{IN} = +12 dBm		-90	-40	dBc
Transmit bypass path rejection	R2F0	@ 2fo (1780 MHz to 1920 MHz)	27	36		dB
Transmit bypass path rejection	R3F0	@ 3fo (2670 MHz to 2880 MHz)	32	36		dB
Input return loss	IS11I			10		dB
Output return loss	IS22I			10		dB
Transition time ⁴	t			3.4		μ\$
ANT to RX1 Path						
Isolation	IS21I		25	35		dB
ANT to RX1 Path, Transmit Bypass Mode					•	
Isolation	IS21I		25	35		dB

Performance is guaranteed only under the conditions listed in this table. Modes are established as indicated in Table 2.

 $^{^2}$ Output power rated at the antenna output. PA output power is actually 1.5 dB higher or +32 dBm for a PouT of +30.5 dBm.

 $^{^3}$ Output power control is the difference between the output power at VPC = 2.25 V and VPC = 0 V.

⁴ Not production tested.

 $^{^{5}~}$ Only the 2^{nd} to 5^{th} harmonics have been production tested. The 6^{th} to 10^{th} harmonics are characterized only.

Evaluation Board Description

The SKY65364-21 Evaluation Board is used to test the performance of the SKY65364-21 T/R FEM. A typical application schematic diagram is provided in Figure 3. An Evaluation Board schematic diagram is provided in Figure 4.

An assembly drawing for the Evaluation Board is shown in Figure 5, and the layer detail is provided in Figure 6.

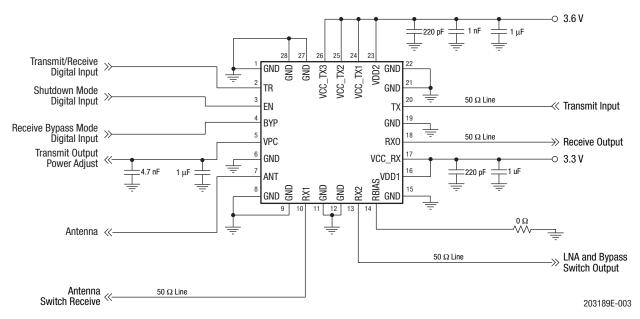
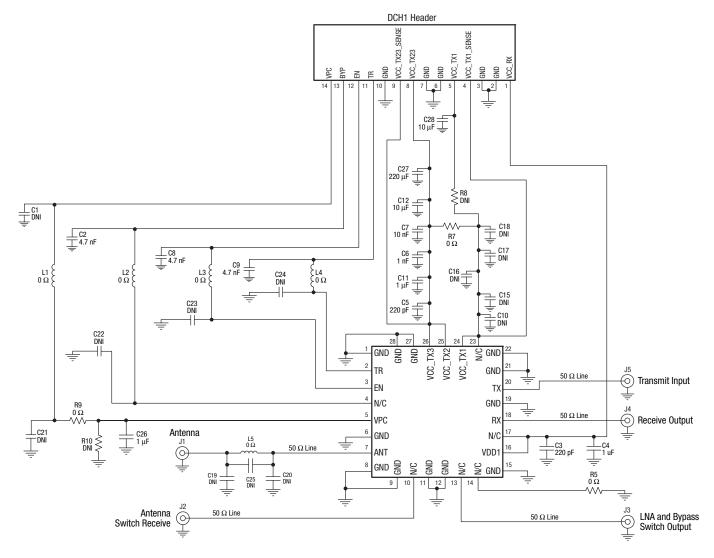


Figure 3. SKY65364-21 Typical Application Schematic



Notes:

Some component labels may be different from the corresponding component symbol shown here. Component values, however, are accurate as of the date of this data sheet.

PCB Recommendations:

Metal Layer 1 = RF traces + control lines. Core thickness between top RF layer and ground plane is critical. Metal Layer 2 = Solid ground plane. No traces routing. Metal Layer 3 and 4 = Control lines + VCC traces (no VCC plane). Pour copper on each layer connected to the ground plane. Use VCC traces in a star distribution pattern. Always use 4 layers.

203189E-004

Figure 4. SKY65364-21 Evaluation Board Schematic

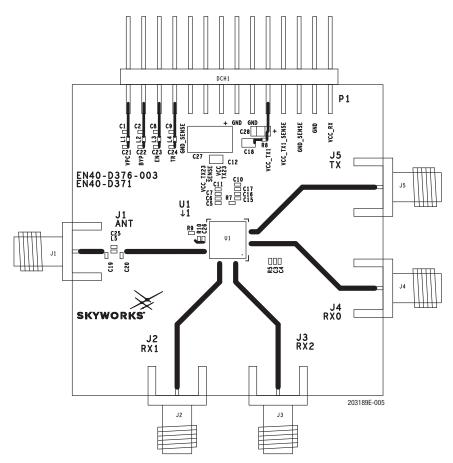


Figure 5. SKY65364-21 Evaluation Board Assembly Diagram

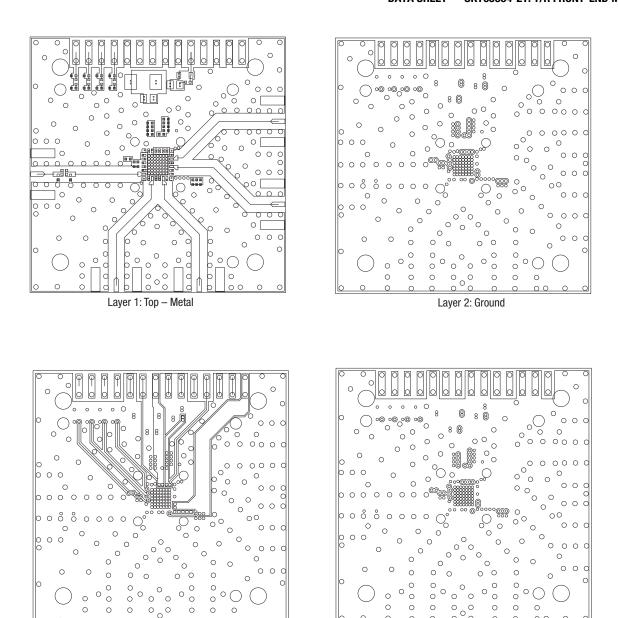


Figure 6. SKY65364-21 Evaluation Board Layer Detail

Layer 3: Ground

203189E-006

Layer 4: Solid Ground Plane

Package Dimensions

The typical part marking is shown in Figure 7, and the footprint drawing is shown in Figure 8. The package dimensions are provided in Figure 9. The tape and reel dimensions are provided in Figure 10.

Package and Handling Information

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SKY65364-21 is rated to Moisture Sensitivity Level 3 (MSL3) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to Skyworks Application Note, *PCB Design and SMT Assembly/Rework Guidelines for MCM-L Packages*, document number 101752.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.

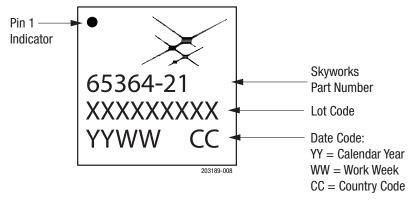


Figure 7. SKY65364-21 Typical Part Marking

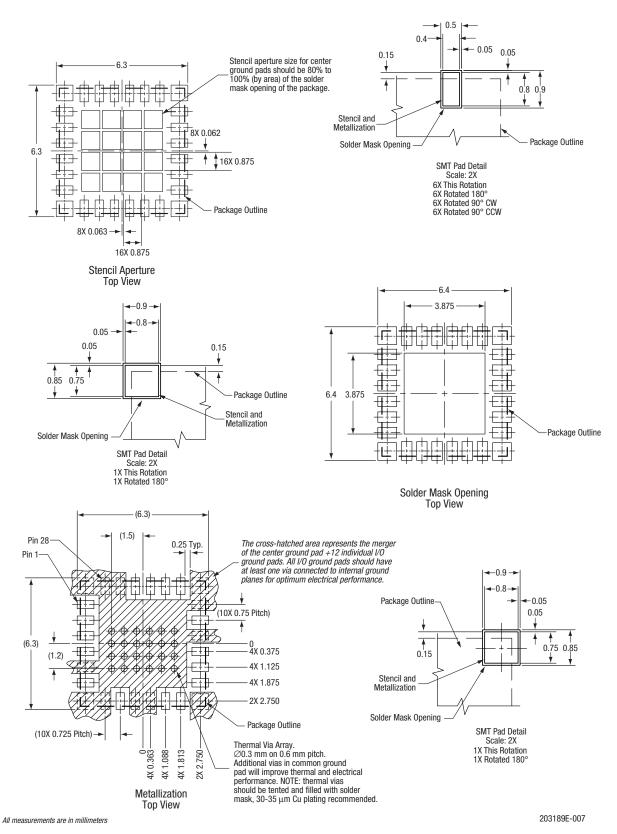
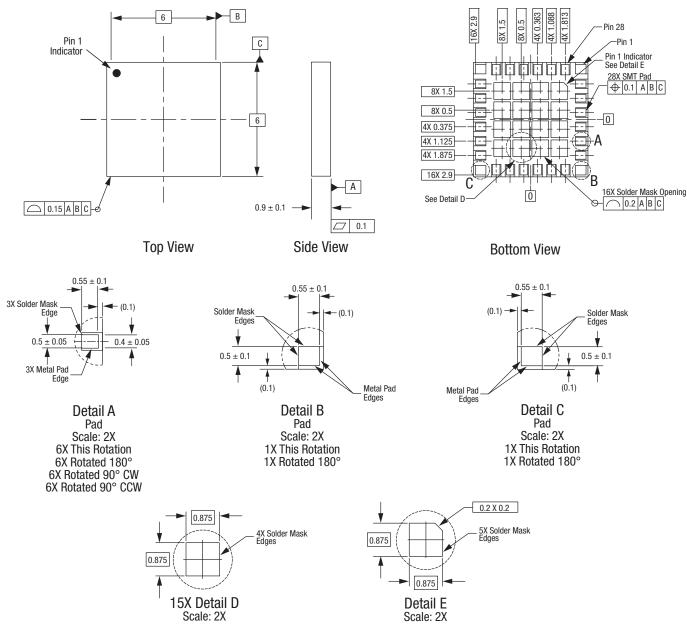


Figure 8. SKY65364-21 Footprint Drawing



Notes:

- 1. All measurements are in millimeters. 2. Dimensions and tolerances according to ASME Y14.5M-1994.

203189-009

Figure 9. SKY65364-21 Package Dimensions

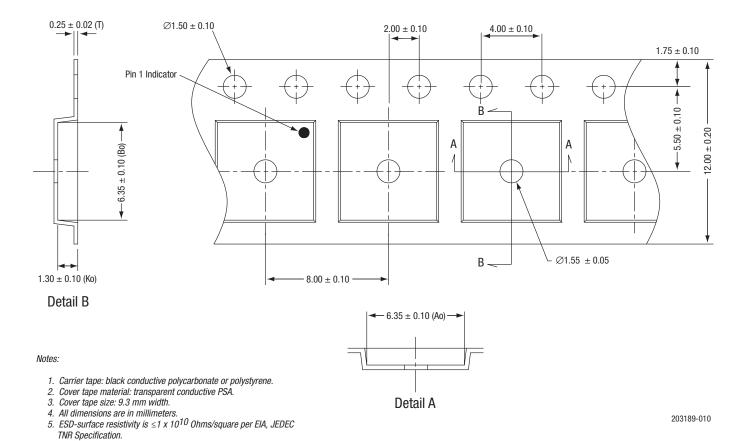


Figure 10. SKY65364-21 Tape and Reel Dimensions

Ordering Information

Product Description	Product Part Number	Evaluation Board Part Number		
SKY65364-21: T/R Front-End Module	SKY65364-21	SKY65364-21EK1		

Copyright © 2012, 2014-2018 Skyworks Solutions, Inc. All Rights Reserved.

Information in this document is provided in connection with Skyworks Solutions, Inc. ("Skyworks") products or services. These materials, including the information contained herein, are provided by Skyworks as a service to its customers and may be used for informational purposes only by the customer. Skyworks assumes no responsibility for errors or omissions in these materials or the information contained herein. Skyworks may change its documentation, products, services, specifications or product descriptions at any time, without notice. Skyworks makes no commitment to update the materials or information and shall have no responsibility whatsoever for conflicts, incompatibilities, or other difficulties arising from any future changes.

No license, whether express, implied, by estoppel or otherwise, is granted to any intellectual property rights by this document. Skyworks assumes no liability for any materials, products or information provided hereunder, including the sale, distribution, reproduction or use of Skyworks products, information or materials, except as may be provided in Skyworks Terms and Conditions of Sale

THE MATERIALS, PRODUCTS AND INFORMATION ARE PROVIDED "AS IS" WITHOUT WARRANTY OF ANY KIND, WHETHER EXPRESS, IMPLIED, STATUTORY, OR OTHERWISE, INCLUDING FITNESS FOR A PARTICULAR PURPOSE OR USE, MERCHANTABILITY, PERFORMANCE, QUALITY OR NON-INFRINGEMENT OF ANY INTELLECTUAL PROPERTY RIGHT; ALL SUCH WARRANTIES ARE HEREBY EXPRESSLY DISCLAIMED. SKYWORKS DOES NOT WARRANT THE ACCURACY OR COMPLETENESS OF THE INFORMATION, TEXT, GRAPHICS OR OTHER ITEMS CONTAINED WITHIN THESE MATERIALS. SKYWORKS SHALL NOT BE LIABLE FOR ANY DAMAGES, INCLUDING BUT NOT LIMITED TO ANY SPECIAL, INDIRECT, INCIDENTAL, STATUTORY, OR CONSEQUENTIAL DAMAGES, INCLUDING WITHOUT LIMITATION, LOST REVENUES OR LOST PROFITS THAT MAY RESULT FROM THE USE OF THE MATERIALS OR INFORMATION, WHETHER OR NOT THE RECIPIENT OF MATERIALS HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGE.

Skyworks products are not intended for use in medical, lifesaving or life-sustaining applications, or other equipment in which the failure of the Skyworks products could lead to personal injury, death, physical or environmental damage. Skyworks customers using or selling Skyworks products for use in such applications do so at their own risk and agree to fully indemnify Skyworks for any damages resulting from such improper use or sale.

Customers are responsible for their products and applications using Skyworks products, which may deviate from published specifications as a result of design defects, errors, or operation of products outside of published parameters or design specifications. Customers should include design and operating safeguards to minimize these and other risks. Skyworks assumes no liability for applications assistance, customer product design, or damage to any equipment resulting from the use of Skyworks products outside of stated published specifications or parameters.

Skyworks and the Skyworks symbol are trademarks or registered trademarks of Skyworks Solutions, Inc. or its subsidiaries in the United States and other countries. Third-party brands and names are for identification purposes only, and are the property of their respective owners. Additional information, including relevant terms and conditions, posted at www.skyworksinc.com, are incorporated by reference.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for RF Front End category:

Click to view products by Skyworks manufacturer:

Other Similar products are found below:

SE2622L-R BGM1032N7E6327XUSA1 LX5586LL SKY85703-11 LX5586HLL LX5586ALL SKY66111-21 SKY65728-11 SKY68000-31 SKY85308-11 SKY85302-11 SKY65724-11 ADTR1107ACCZ LMP91051MTX/NOPB SE5501L-R QPF4519SR SE5503A-R ADA8282WBCPZ ADRF5545ABCPZN ADRF5545ABCPZN-R7 AD8283WBCPZ AD8284WCSVZ ADRF5547BCPZN ADRF5547BCPZN ADRF5549BCPZN-R7 HV7350K6-G SE5516A-R MCP2030-I/SL MAX2009ETI+ MAX2078CTK+ MAX2335ETI+ MAX2678GTB/V+T MD2131K7-G MD2134K7-G RFFM6903TR13 HV7351K6-G MCP2035-I/ST SE2614BT-R SE2438T-R SST12LF02-QXCE SST12LF09-Q3CE RFX2401C RFX2402E SKY85201-11 RFFM4591FTR7 RFFM8211TR7 RFFM4293TR7 RFFM4203TR7 RFFM5765QTR7